

VI TELEFILTER

Development specification

TFS 380H 1/5

Measurement condition

Ambient temperature: 23 °C
Input power level: 0 dBm
Terminating impedances at f_C *: input: t.b.d.
output: t.b.d.

Characteristics

Remark:

Reference level for the relative attenuation a_{rel} of the TFS 380H is the attenuation at 380 MHz. The nominal frequency f_N is fixed at 380 MHz without tolerance. The centre frequency f_C is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_g . The given values for the relative attenuation a_{rel} and for the group delay ripple have to be reached at the frequencies given below even if the centre frequency f_C is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_C .

D a t a		typ. value	tolerance / limit
Insertion loss at f_N (reference level)		-	max. 11 dB
Nominal frequency	f_N	-	380 MHz
Centre frequency	f_C	380 MHz	$\pm 0,4$ MHz
Passband	PB	-	$f_N \pm 2$ MHz
Amplitude variation within PB		-	max. 1,5 dB
Relative attenuation			
f_C	...	$f_C \pm 3$ MHz	max. 1 dB
$f_C \pm 3$ MHz	...	$f_C \pm 3,75$ MHz	max. 3 dB
$f_C \pm 7,5$ MHz	...	$f_C \pm 50$ MHz	min. 30 dB
Group delay ripple in $f_N \pm 2,5$ MHz		-	max. 75 ns
Temperature coefficient of frequency (TC_f)**		t.b.d.	-
Frequency deviation of f_C over temperature T:		$\Delta f_C(\text{Hz}) = TC_f(\text{ppm/K}) \times (T - T_A) \times f_{CAT}(\text{MHz})$	
Operating temperature range		-	- 40 °C... + 85 °C
Storage temperature range		-	- 40 °C... + 85 °C

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

generated : _____

checked / approved : _____

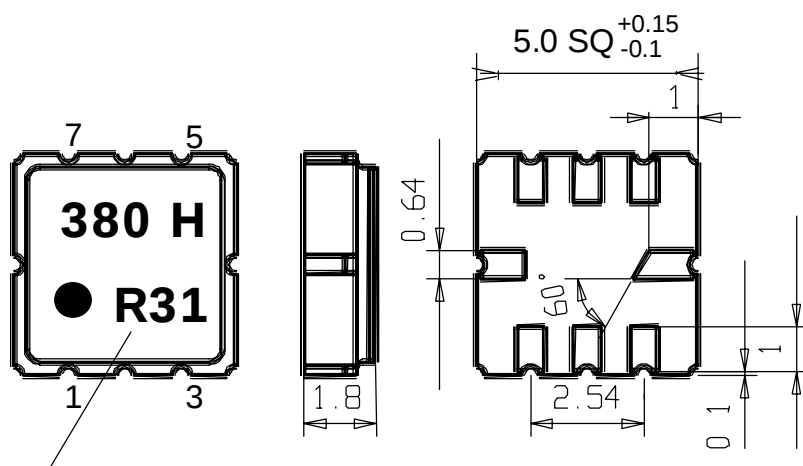
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Construction, pin configuration and 50 Ω - matching network

(All dimensions in mm)



date code

Pin 1 Output
Pin 2 Ground
Pin 3 Input
Pin 4 Package Ground

Pin 5 Input
Pin 6 Ground
Pin 7 Output
Pin 8 Package ground

date code: year + week
N 2001
P 2002
R 2003
...

50 Ohm test circuit

differential, matching t.b.d.

Stability Characteristics

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 18 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 30 min. each / 10 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: twice max.;
for temperature conditions, please refer to the attached "Air reflow temperature conditions" on page 4;

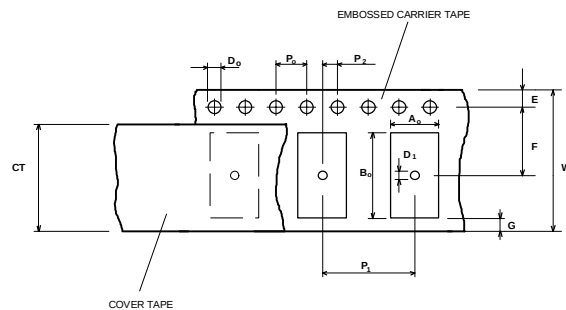
Packing

Tape & Reel: IEC 286 - 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;
max. pieces of filters per reel:
reel of empty components at start:
reel of empty components at start including leader:
trailer

3000
min 300 mm
min 500 mm
min 300 mm

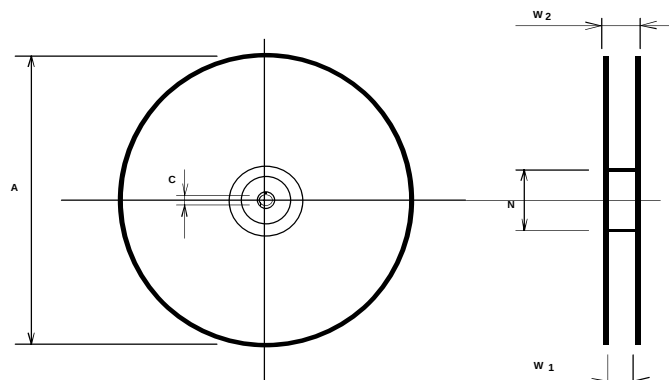
Tape (all dimensions in mm)

W : 12 ± 0,3
Po : 4 ± 0,1
Do : 1,5 ± 0,1
E : 1,75 ± 0,1
F : 5,5 ± 0,05
G (min) : 0,75
P2 : 2 ± 0,05
P1 : 8 ± 0,1
D1(min) : 1,5
Ao : 5,3 ± 0,1
Bo : 5,3 ± 0,1
CT : 9,5 ± 0,1



Reel (all dimensions in mm):

A : 330
W1 : 12,4 + 2 / 0
W2 (max) : 18,4
N (min) : 50
C : 13 + 0,5 / -0,2



The minimum bending radius is 45 mm. The mounting surface of the filters faces the bottom side of the embossed carrier tape. Markings on the filters can be read if the upper side of the carrier tape is regarded with the sprocket holes on its right.

Air reflow temperature conditions

1st and 2nd air reflow profile

Name:	pre-heating periods	main-heating periods	peak temperature
Temperature:	150 °C - 170 °C	over 200 °C	255 °C ± 5 °C
Time:	60 sec. - 90 sec.	20 sec. - 25 sec.	

Chip-mount air reflow profile

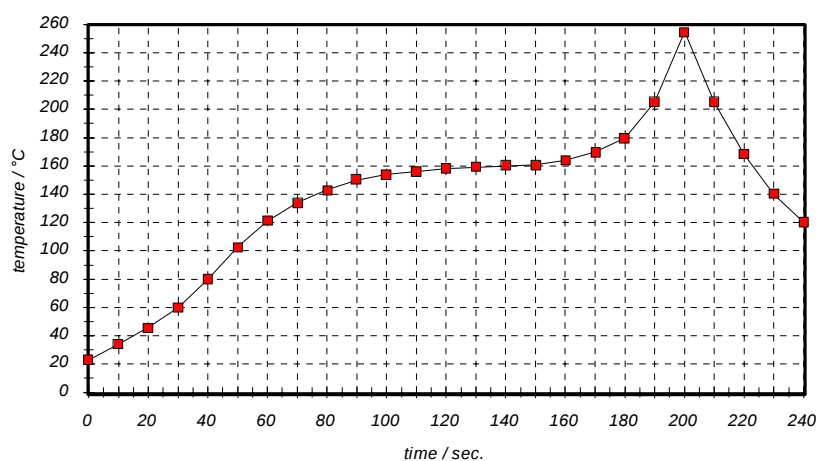


Table for temperature vs. time during the air reflow process

Tolerance of temperatures: ± 5 °C

time / sec.	temperature / °C	time / sec.	temperature / °C
0	23	140	160
10	34	150	161
20	46	160	164
30	60	170	170
40	80	180	180
50	103	190	205
60	121	195	230
70	134	200	255
80	143	205	230
90	150	210	205
100	154	215	180
110	156	220	165
120	158	230	140
130	159	240	120

History

Version	Reason of Changes	Name	Date
1.0	- generation of development specification	Pfeiffer	29.07.2003